

10Amp. Schottky Barrier Rectifiers

MBR1060E3

$I_{F(AV)}$	$2 \times 5A$
V_{RRM}	60V
T_j	175°C
V_F	0.58V

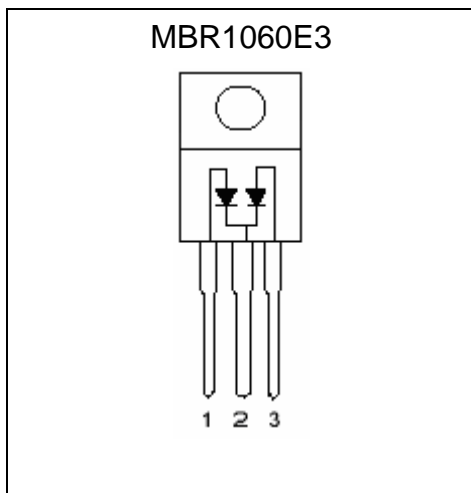
Features

- 175°C operating junction temperature
- Low V_F and low I_R type
- Metal silicon junction, major carrier conduction
- 10A total (5A per diode leg)
- Guardring for stress protection
- Low power loss, high efficiency
- High surge capability
- High temperature soldering guaranteed : 260°C/10s, 0.25”(6.35mm) from case
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection application
- RoHS compliant package

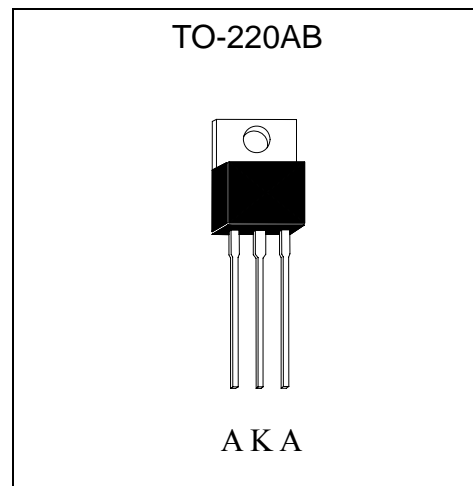
Mechanical Data

- Case: JEDEC TO-220AB molded plastic
- Mounting Position: Any
- Weight: 0.08 ounce, 2.24 grams
- Terminals: Pure tin plated, lead-free, solderable per MIL-STD-750 method 2026
- Epoxy: UL 94V-0 rate flame retardant
- Mounting Torque : 5 in-lbs max

Equivalent Circuit



Outline



**Maximum Ratings and Electrical Characteristics (Per Diode Leg)**

(Rating at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.)

Parameter	Symbol	Min.	Typ.	Max.	Units
Maximum Recurrent peak reverse voltage	V_{RRM}			60	V
Maximum RMS voltage	V_{RMS}			42	V
Maximum DC blocking voltage	V_{DC}			60	V
Maximum instantaneous forward voltage at (Note 1)	$I_F=5A, T_C=25^\circ C$			0.76	V
	$I_F=5A, T_C=125^\circ C$		0.58	0.62	
	$I_F=10A, T_C=25^\circ C$			0.85	
	$I_F=10A, T_C=125^\circ C$			0.71	
Maximum Average forward rectified current @ $T_C=145^\circ C$	Per Diode			5	A
	Per Device			10	
Non-repetitive peak forward surge current @ 8.3ms single half sine wave superimposed on rated load (JEDEC method)	I_{FSM}			110	A
Peak repetitive reverse surge current, $T_J < 175^\circ C$ (Note 1)	I_{RRM}			2.5	A
Maximum instantaneous reverse current at	$V_R=60V, T_C=25^\circ C$			10	μA
	$V_R=60V, T_C=125^\circ C$			10	mA
Voltage rate of change, (rated V_R)	dV/dt			10,000	V/ μs
Typical junction capacitance @ $f=1MHz$ and applied 5V reverse voltage	C_J		110		pF
ESD susceptibility (Note 2)				8000	V
Storage temperature range	T_{stg}	-65		+175	$^\circ C$
Operating junction temperature range	T_J	-65		+175	$^\circ C$

Notes : 1. 2.0 μs pulse width, $f=1.0kHz$ 2. Human body model, 1.5k Ω in series with 100pF**Thermal Data**

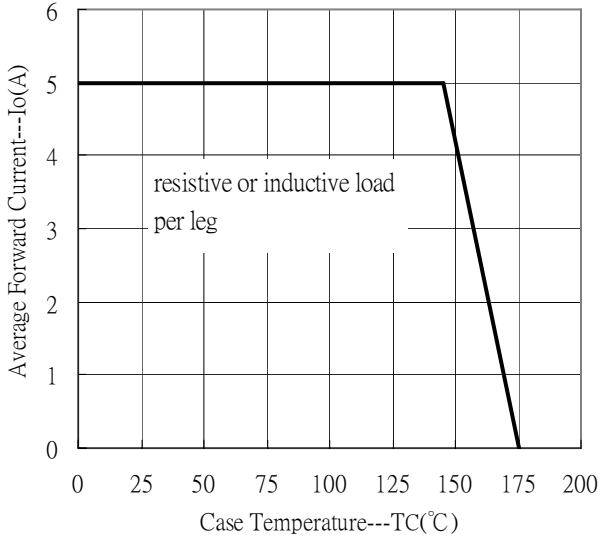
Parameter	Symbol	Value	Unit
Maximum Thermal Resistance, Junction-to-case	$R_{th,j-c}$	2	$^\circ C/W$
Maximum Thermal Resistance, Junction-to-ambient	$R_{th,j-a}$	60	$^\circ C/W$

Ordering Information

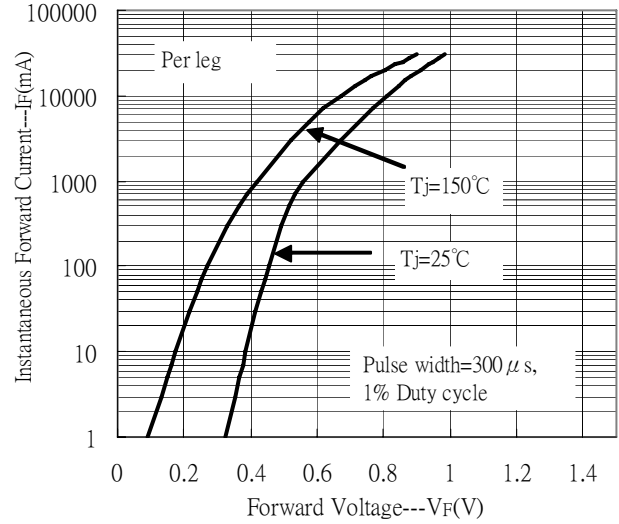
Device	Package	Shipping	Marking
MBR1060E3	TO-220AB (RoHS compliant package)	50 pcs / Tube, 40 Tubes/Box	1060

Typical Characteristics

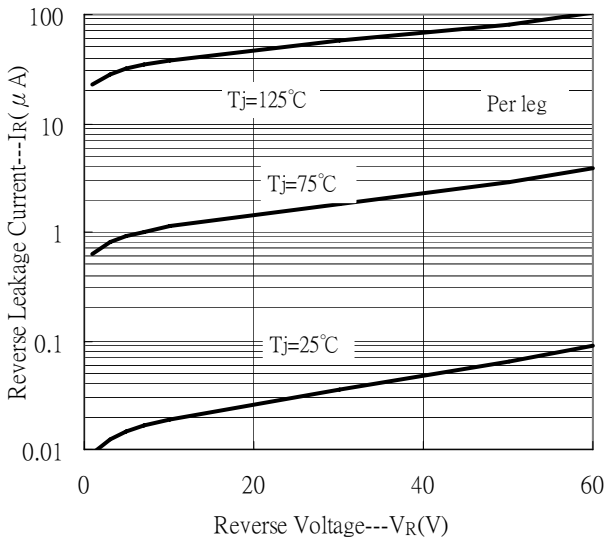
Forward Current Derating Curve



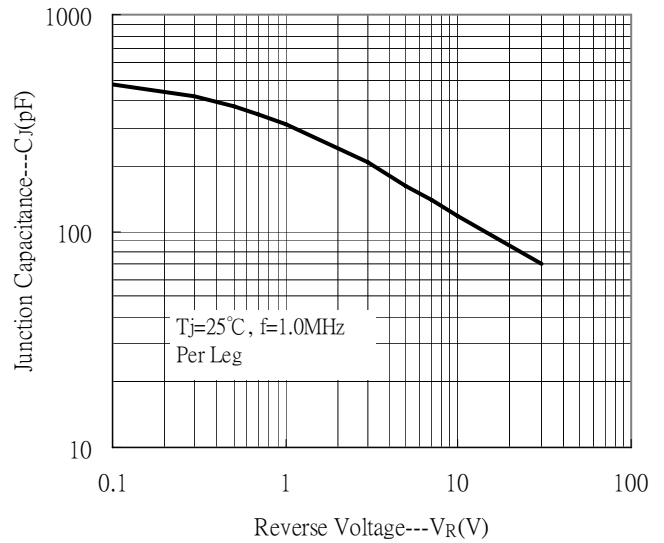
Forward Current vs Forward Voltage



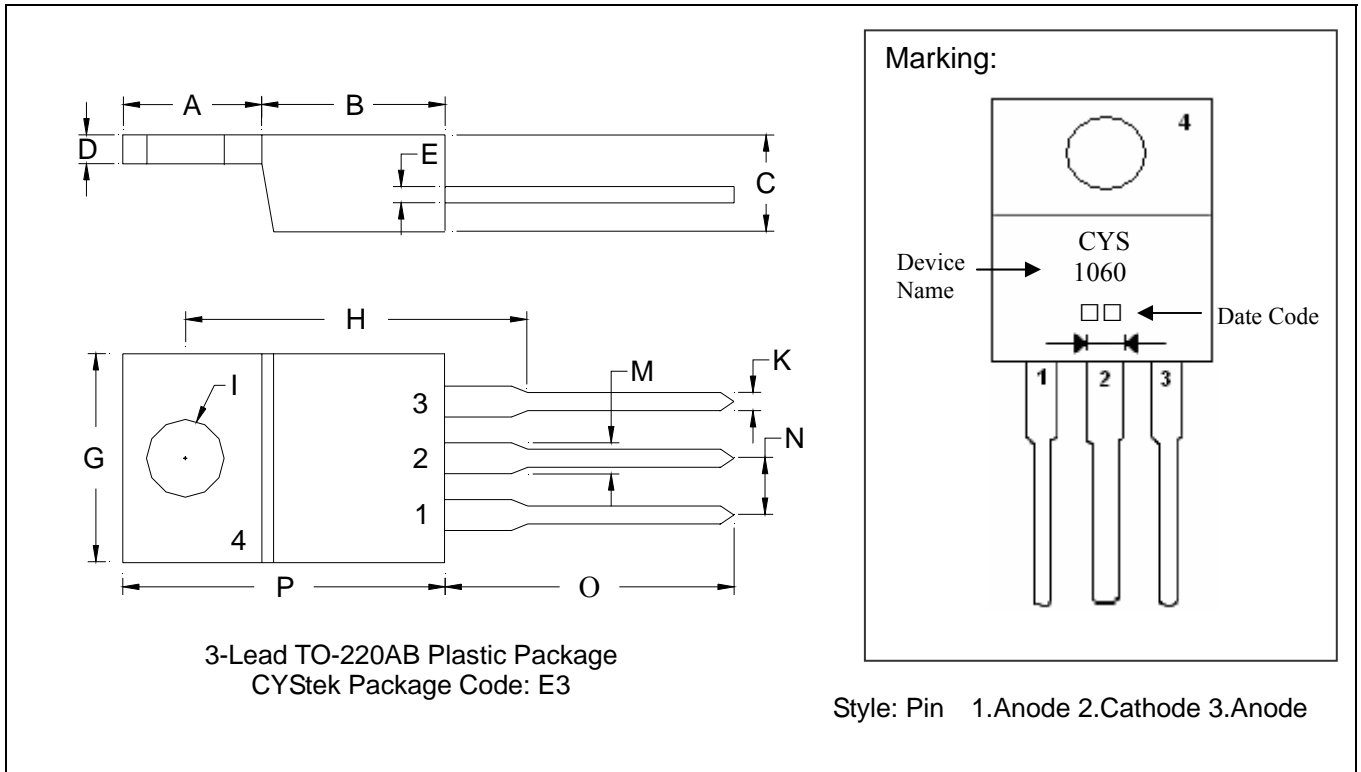
Reverse Leakage Current vs Reverse Voltage



Junction Capacitance vs Reverse Voltage



TO-220AB Dimension



*: Typical

DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.2197	0.2949	5.58	7.49	I	-	*0.1508	-	*3.83
B	0.3299	0.3504	8.38	8.90	K	0.0295	0.0374	0.75	0.95
C	0.1732	0.185	4.40	4.70	M	0.0449	0.0551	1.14	1.40
D	0.0453	0.0547	1.15	1.39	N	-	*0.1000	-	*2.54
E	0.0138	0.0236	0.35	0.60	O	0.5000	0.5618	12.70	14.27
G	0.3803	0.4047	9.66	10.28	P	0.5701	0.6248	14.48	15.87
H	-	*0.6398	-	*16.25					

Notes: 1.Controlling dimension: millimeters.
 2.Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material.
 3.If there is any question with packing specification or packing method, please contact your local CYStek sales office.

Material:

- Lead: Pure tin plated.
- Mold Compound: Epoxy resin family, flammability solid burning class: UL94V-0.

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